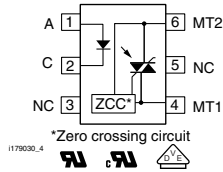
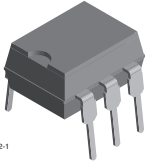


Optocoupler, Phototriac Output, Zero Crossing, High dV/dt, Low Input Current



DESCRIPTION

The IL410 and IL4108 consists of a GaAs IRLED optically coupled to a photosensitive zero crossing TRIAC network. The TRIAC consists of two inverse parallel connected monolithic SCRs. These three semiconductor are assembled in a six pin dual in-line package.

High input sensitivity is achieved by using an emitter follower phototransistor and a cascaded SCR predriver resulting in an LED trigger current of less than 2 mA (DC). The use of a proprietary dV/dt clamp results in a static dV/dt of greater than 10 kV/ms. This clamp circuit has a MOSFET that is enhanced when high dV/dt spikes occur between MT1 and MT2 of the TRIAC. When conducting, the FET clamps the base of the phototransistor, disabling the first stage SCR predriver.

The zero cross line voltage detection circuit consists of two enhancement MOSFETS and a photodiode. The inhibit voltage of the network is determined by the enhancement voltage of the N-channel FET. The P-channel FET is enabled by a photocurrent source that permits the FET to conduct the main voltage to gate on the N-channel FET. Once the main voltage can enable the N-channel, it clamps the base of the phototransistor, disabling the first stage SCR predriver.

The 600 V, 800 V blocking voltage permits control of off-line voltages up to 240 V_{AC}, with a safety factor of more than two, and is sufficient for as much as 380 V_{AC}.

The IL410, IL4108 isolates low-voltage logic from 120 V_{AC}, 240 V_{AC}, and 380 V_{AC} lines to control resistive, inductive, or capacitive loads including motors, solenoids, high current thyristors or TRIAC and relays.

FEATURES

- High input sensitivity
- I_{FT} = 2 mA, PF = 1.0
- I_{FT} = 5 mA, PF ≤ 1.0
- 300 mA on-state current
- Zero voltage crossing detector
- 600 V, 800 V blocking voltage
- High static dV/dt 10 kV/μs
- Very low leakage < 10 μA
- Isolation test voltage 5300 V_{RMS}
- Small 6 pin DIP package
- Compliant to RoHS Directive 2002/95/EC and in accordance to WEEE 2002/96/EC

APPLICATIONS

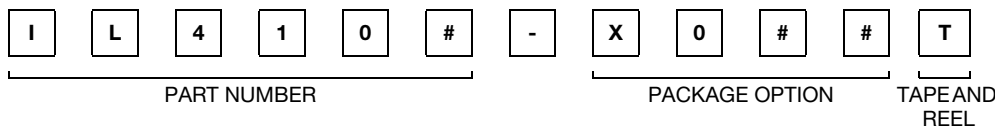
- Solid-state relays
- Industrial controls
- Office equipment
- Consumer appliances

AGENCY APPROVALS

- UL1577, file no. E52744 system code H or J, double protection
- CSA 93751
- DIN EN 60747-5-5 (VDE 0884) available with option 1


**RoHS
COMPLIANT**

ORDERING INFORMATION



AGENCY CERTIFIED/PACKAGE	BLOCKING VOLTAGE V _{DRM} (V)	
	600	800
UL		
DIP-6	IL410	IL4108
DIP-6, 400 mil, option 6	IL410-X006	IL4108-X006
SMD-6, option 7	IL410-X007T ⁽¹⁾	IL4108-X007T ⁽¹⁾
SMD-6, option 8	IL410-X008T	-
SMD-6, option 9	IL410-X009T ⁽¹⁾	IL4108-X009T ⁽¹⁾
VDE, UL	600	800
DIP-6	IL410-X001	IL4108-X001
DIP-6, 400 mil, option 6	IL410-X016	IL4108-X016
SMD-6, option 7	IL410-X017	IL4108-X017
SMD-6, option 9	IL410-X019T ⁽¹⁾	-

Note

⁽¹⁾ Also available in tubes, do not put T on the end.

ABSOLUTE MAXIMUM RATINGS (1) ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)					
PARAMETER	TEST CONDITION	PART	SYMBOL	VALUE	UNIT
INPUT					
Reverse voltage			V_R	6	V
Forward current			I_F	60	mA
Surge current			I_{FSM}	2.5	A
Power dissipation			P_{diss}	100	mW
Derate from 25 °C				1.33	mW/°C
OUTPUT					
Peak off-state voltage		IL410	V_{DRM}	600	V
		IL4108	V_{DRM}	800	V
RMS on-state current			I_{TM}	300	mA
Single cycle surge current				3	A
Total power dissipation			P_{diss}	500	mW
Derate from 25 °C				6.6	mW/°C
COUPLER					
Isolation test voltage between emitter and detector	$t = 1\text{ s}$		V_{ISO}	5300	V_{RMS}
Pollution degree (DIN VDE 0109)				2	
Creepage distance				≥ 7	mm
Clearance distance				≥ 7	mm
Comparative tracking index per DIN IEC112/VDE 0303 part 1, group IIIa per DIN VDE 6110			CTI	≥ 175	
Isolation resistance	$V_{IO} = 500\text{ V}, T_{amb} = 25\text{ }^{\circ}\text{C}$		R_{IO}	$\geq 10^{12}$	Ω
	$V_{IO} = 500\text{ V}, T_{amb} = 100\text{ }^{\circ}\text{C}$		R_{IO}	$\geq 10^{11}$	Ω
Storage temperature range			T_{stg}	- 55 to + 150	°C
Ambient temperature			T_{amb}	- 55 to + 100	°C
Soldering temperature (2)	max. $\leq 10\text{ s}$ dip soldering $\geq 0.5\text{ mm}$ from case bottom		T_{sld}	260	°C

Notes

- (1) Stresses in excess of the absolute maximum ratings can cause permanent damage to the device. Functional operation of the device is not implied at these or any other conditions in excess of those given in the operational sections of this document. Exposure to absolute maximum ratings for extended periods of the time can adversely affect reliability.
- (2) Refer to reflow profile for soldering conditions for surface mounted devices (SMD). Refer to wave profile for soldering conditions for through hole devices (DIP).



Optocoupler, Phototriac Output, Zero Crossing, High dV/dt, Low Input Current Vishay Semiconductors

ELECTRICAL CHARACTERISTICS (T _{amb} = 25 °C, unless otherwise specified)							
PARAMETER	TEST CONDITION	PART	SYMBOL	MIN.	TYP.	MAX.	UNIT
INPUT							
Forward voltage	I _F = 10 mA		V _F		1.16	1.35	V
Reverse current	V _R = 6 V		I _R		0.1	10	μA
Input capacitance	V _F = 0 V, f = 1 MHz		C _{IN}		25		pF
Thermal resistance, junction to ambient			R _{thja}		750		°C/W
OUTPUT							
Off-state voltage	I _{D(RMS)} = 70 μA	IL410	V _{D(RMS)}	424	460		V
		IL4108	V _{D(RMS)}	565			V
Repetitive peak off-state voltage	I _{DRM} = 100 μA	IL410	V _{DRM}	600			V
		IL4108	V _{DRM}	800			V
Off-state current	V _D = V _{DRM} , T _{amb} = 100 °C, I _F = 0 mA		I _{D(RMS)1}		10	100	μA
On-state voltage	I _T = 300 mA		V _{TM}		1.7	3	V
On-state current	PF = 1, V _{T(RMS)} = 1.7 V		I _{TM}			300	mA
Surge (non-repetitive), on-state current	f = 50 Hz		I _{TSM}			3	A
Trigger current 1	V _D = 5 V		I _{FT1}			2	mA
Trigger current 2	V _{OP} = 220 V _{RMS} , f = 50 Hz, T _j = 100 °C, t _{plF} > 10 ms		I _{FT2}			6	mA
Trigger current temp. gradient			ΔI _{FT1} /ΔT _j		7	14	μA/°C
			ΔI _{FT2} /ΔT _j		7	14	μA/°C
Inhibit voltage temp. gradient			ΔV _{DINH} /ΔT _j		- 20		mV/°C
Off-state current in inhibit state	I _F = I _{FT1} , V _{DRM}		I _{DINH}		50	200	μA
Holding current			I _H		65	500	μA
Latching current	V _T = 2.2 V		I _L			500	μA
Zero cross inhibit voltage	I _F = Rated I _{FT}		V _{IH}		15	25	V
Turn-on time	V _{RM} = V _{DM} = V _{D(RMS)}		t _{on}		35		μs
Turn-off time	PF = 1, I _T = 300 mA		t _{off}		50		μs
Critical rate of rise of off-state voltage	V _D = 0.67 V _{DRM} , T _j = 25 °C		dV/dt _{cr}	10 000			V/μs
	V _D = 0.67 V _{DRM} , T _j = 80 °C		dV/dt _{crq}	5000			V/μs
Critical rate of rise of voltage at current commutation	V _D = 230 V _{RMS} , I _D = 300 mA _{RMS} , T _J = 25 °C		dV/dt _{crq}		8		V/μs
	V _D = 230 V _{RMS} , I _D = 300 mA _{RMS} , T _J = 85 °C		dV/dt _{crq}		7		V/μs
Critical rate of rise of on-state current commutation	V _D = 230 V _{RMS} , I _D = 300 mA _{RMS} , T _J = 25 °C		dI/dt _{crq}		12		A/ms
Thermal resistance, junction to ambient			R _{thja}		150		°C/W
COUPLER							
Critical rate of rise of coupled input/output voltage	I _T = 0 A, V _{RM} = V _{DM} = V _{D(RMS)}		dV _{IO} /dt	10 000			V/μs
Common mode coupling capacitance			C _{CM}		0.01		pF
Capacitance (input to output)	f = 1 MHz, V _{IO} = 0 V		C _{IO}		0.8		pF
Isolation resistance	V _{IO} = 500 V, T _{amb} = 25 °C		R _{IO}		≥ 10 ¹²		Ω
	V _{IO} = 500 V, T _{amb} = 100 °C		R _{IO}		≥ 10 ¹¹		Ω

Note

- Minimum and maximum values are testing requirements. Typical values are characteristics of the device and are the result of engineering evaluation. Typical values are for information only and are not part of the testing requirements.

TYPICAL CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

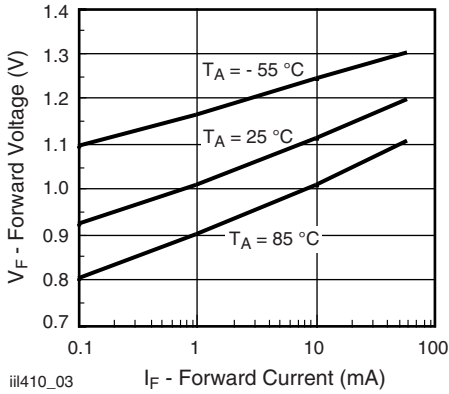


Fig. 1 - Forward Voltage vs. Forward Current

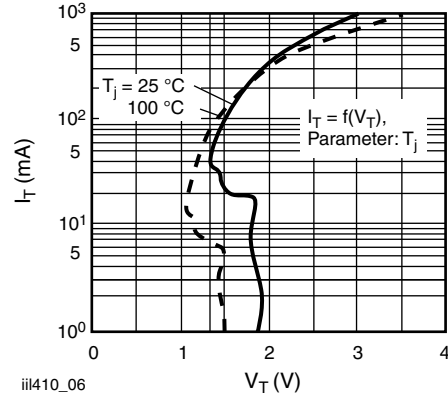


Fig. 4 - Typical Output Characteristics

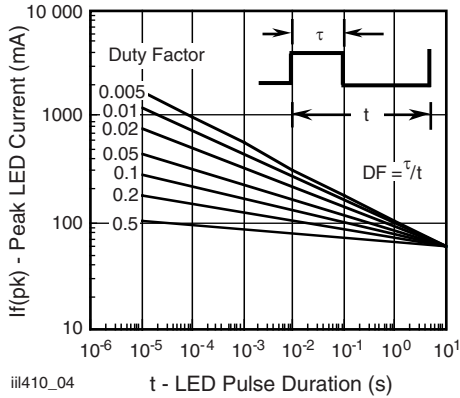


Fig. 2 - Peak LED Current vs. Duty Factor, τ

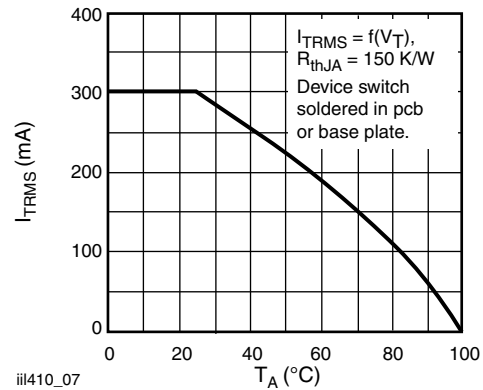


Fig. 5 - Current Reduction

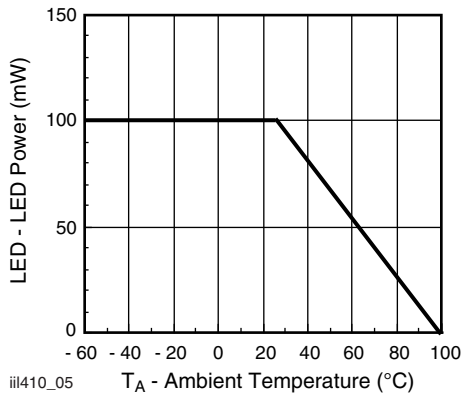


Fig. 3 - Maximum LED Power Dissipation

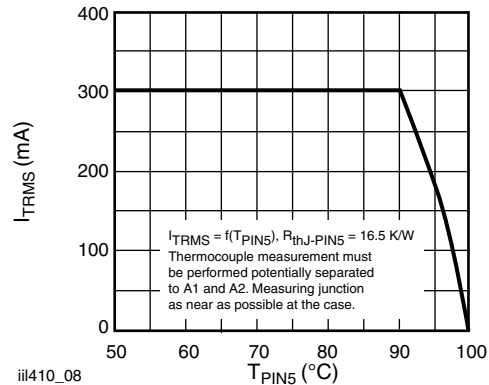


Fig. 6 - Current Reduction

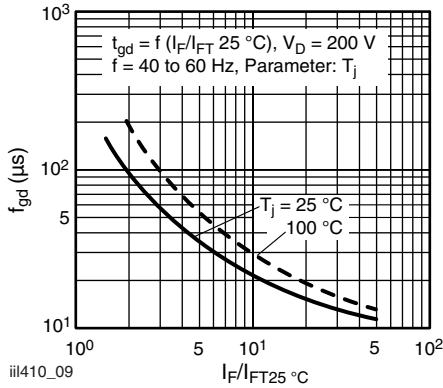


Fig. 3 - Typical Trigger Delay Time

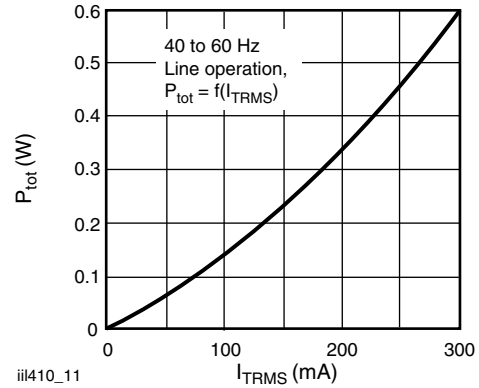


Fig. 8 - Power Dissipation 40 Hz to 60 Hz Line Operation

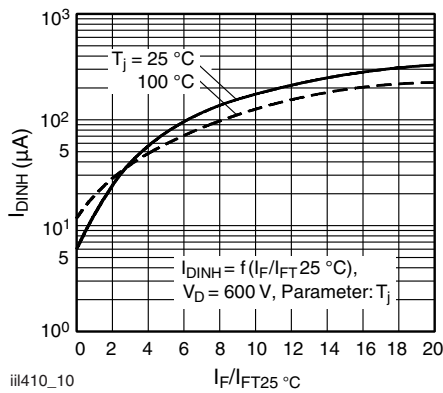
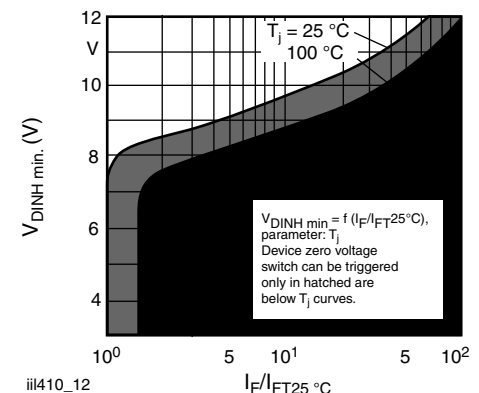

 Fig. 7 - Off-State Current in Inhibited State vs. $I_F/I_{FT} 25^\circ\text{C}$


Fig. 9 - Typical Static Inhibit Voltage Limit

TRIGGER CURRENT VS. TEMPERATURE AND VOLTAGE

The trigger current of the IL410, 4108 has a positive temperature gradient and also is dependent on the terminal voltage as shown as the fig. 11.

For the operating voltage 250 V_{RMS} over the temperature range - 40 °C to 85 °C, the I_F should be at least 2.3 x of the I_{FT1} (1.3 mA, max.).

Considering - 30 % degradation over time, the trigger current minimum is $I_F = 1.3 \times 2.3 \times 130 \% = 4 \text{ mA}$

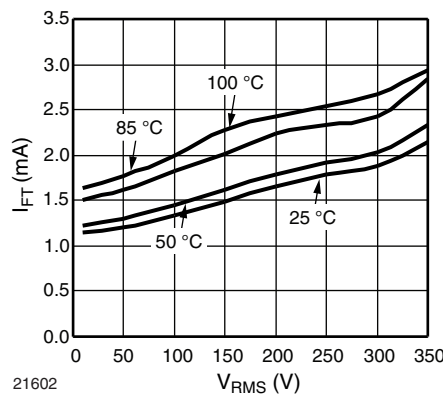


Fig. 11 - Trigger Current vs. Temperature and Operating Voltage (50 Hz)

INDUCTIVE AND RESISTIVE LOADS

For inductive loads, there is phase shift between voltage and current, shown in the fig. 12.

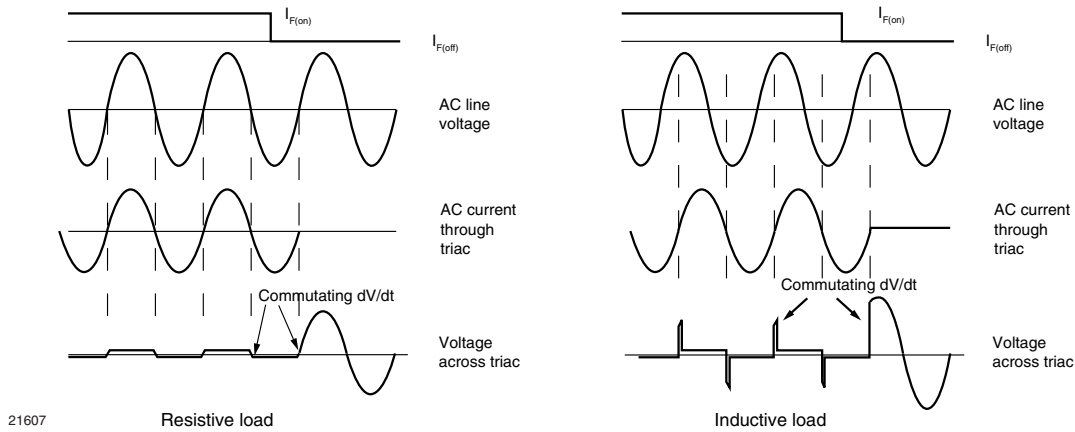


Fig. 12 - Waveforms of Resistive and Inductive Loads

The voltage across the triac will rise rapidly at the time the current through the power handling triac falls below the holding current and the triac ceases to conduct. The rise rate of voltage at the current commutation is called commutating dV/dt. There would be two potential problems for ZC phototriac control if the commutating dV/dt is too high. One is lost control to turn off, another is failed to keep the triac on.

Lost control to turn off

If the commutating dV/dt is too high, more than its critical rate (dV/dt_{crq}), the triac may resume conduction even if the LED drive current I_F is off and control is lost.

In order to achieve control with certain inductive loads of power factors is less than 0.8, the rate of rise in voltage (dV/dt) must be limited by a series RC network placed in parallel with the power handling triac. The RC network is called snubber circuit. Note that the value of the capacitor increases as a function of the load current as shown in fig. 13.

Failed to keep on

As a zero-crossing phototriac, the commutating dV/dt spikes can inhibit one half of the TRIAC from keeping on if the spike potential exceeds the inhibit voltage of the zero cross detection circuit, even if the LED drive current I_F is on.

This hold-off condition can be eliminated by using a snubber and also by providing a higher level of LED drive current. The higher LED drive provides a larger photocurrent which causes the triac to turn-on before the commutating spike has activated the zero cross detection circuit. Fig. 14 shows the relationship of the LED current for power factors of less than 1.0. The curve shows that if a device requires 1.5 mA for a resistive load, then 1.8 times (2.7 mA) that amount would be required to control an inductive load whose power factor is less than 0.3 without the snubber to dump the spike.

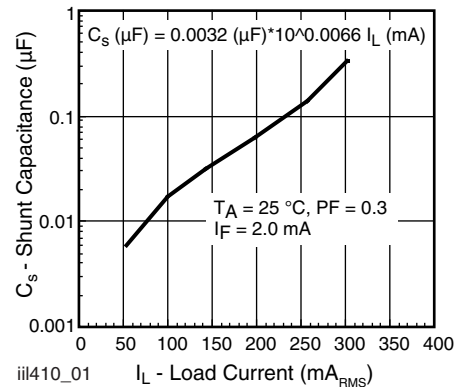


Fig. 10 - Shunt Capacitance vs. Load Current

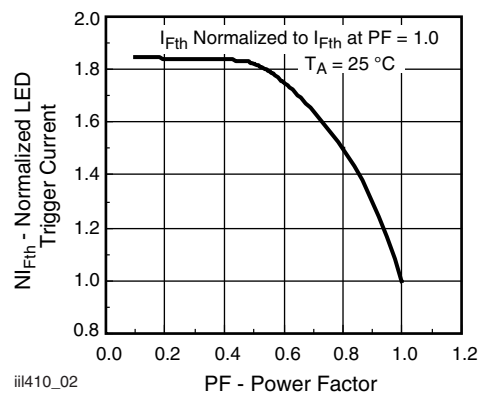


Fig. 11 - Normalized LED Trigger Current vs. Power Factor

APPLICATIONS

Direct switching operation:

The IL410, IL4108 isolated switch is mainly suited to control synchronous motors, valves, relays and solenoids. Fig. 15 shows a basic driving circuit. For resistive load the snubber circuit $R_S C_S$ can be omitted due to the high static dV/dt characteristic.

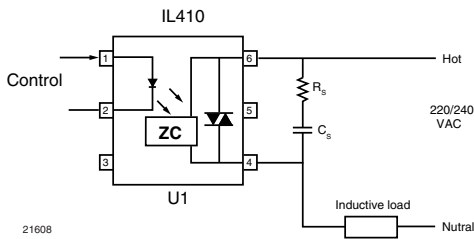


Fig. 15 - Basic Direct Load Driving Circuit

Indirect switching operation:

The IL410, IL4108 switch acts here as an isolated driver and thus enables the driving of power thyristors and power triacs by microprocessors. Fig. 16 shows a basic driving circuit of inductive load. The resistor R1 limits the driving current pulse which should not exceed the maximum permissible surge current of the IL410, IL4108. The resistor R_G is needed only for very sensitive thyristors or triacs from being triggered by noise or the inhibit current.

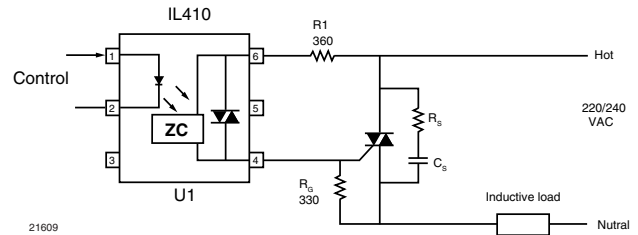
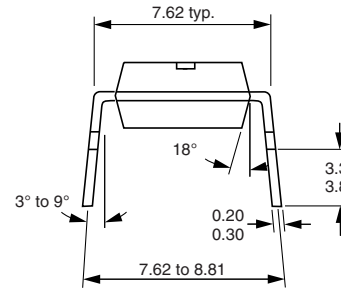
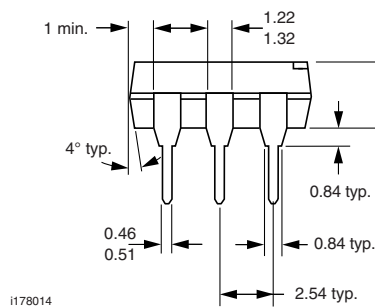
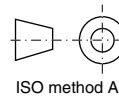
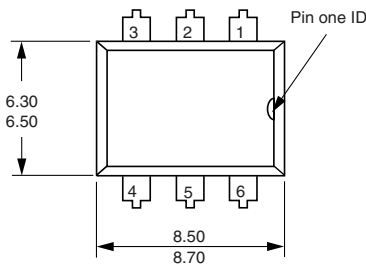
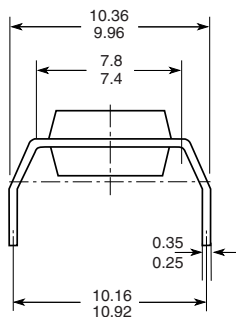


Fig. 16 - Basic Power Triac Driver Circuit

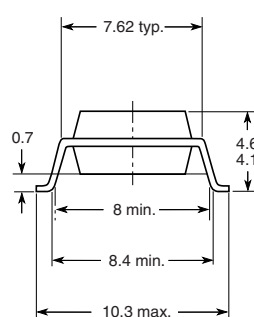
PACKAGE DIMENSIONS in millimeters



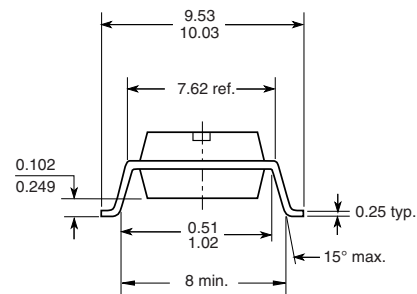
Option 6



Option 7



Option 9



18450



Disclaimer

All product specifications and data are subject to change without notice.

Vishay Intertechnology, Inc., its affiliates, agents, and employees, and all persons acting on its or their behalf (collectively, "Vishay"), disclaim any and all liability for any errors, inaccuracies or incompleteness contained herein or in any other disclosure relating to any product.

Vishay disclaims any and all liability arising out of the use or application of any product described herein or of any information provided herein to the maximum extent permitted by law. The product specifications do not expand or otherwise modify Vishay's terms and conditions of purchase, including but not limited to the warranty expressed therein, which apply to these products.

No license, express or implied, by estoppel or otherwise, to any intellectual property rights is granted by this document or by any conduct of Vishay.

The products shown herein are not designed for use in medical, life-saving, or life-sustaining applications unless otherwise expressly indicated. Customers using or selling Vishay products not expressly indicated for use in such applications do so entirely at their own risk and agree to fully indemnify Vishay for any damages arising or resulting from such use or sale. Please contact authorized Vishay personnel to obtain written terms and conditions regarding products designed for such applications.

Product names and markings noted herein may be trademarks of their respective owners.